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## **AMENDMENTS TO THE CLAIMS**

This listing of claims replaces all prior versions, and listings, of claims in the application.

- 1-6. (Canceled)
- 7. (Currently amended) A method [[of]] for fabricating a Bi-containing film, comprising: forming the Bi-containing film onto a substrate at a deposition rate of  $0.1 10 \mu m/min$  by sputtering in a vacuum chamber[[.]], and

heat processing the Bi-containing thin film at a temperature within a range of 250-270°C.

- 8. (Currently Amended) The method of claim 7, wherein the Bi-containing film has a MR (magnetoresistance) ratio of approximately 600 % or more at room temperature and not less than 30,000 % at 4 K under a magnetic field of 9T.
  - 9. (Canceled)
- 10. (Currently Amended) A magnetic field sensor comprising: a Bi-containing thin film as a mesa and a magnetic substance[[,]] at both sides of the mesa as a flux concentrator, wherein the Bi-containing thin film has a MR ratio of approximately 600% or more at room temperature and not less than 30,000% at 4K when a magnetic filed of 9T is applied. wherein a the mesa comprises the Bi thin film fabricated by the method of claim 1 or claim 7 is fabricated as a mesa by photolithography or electron beam lithography, and a the magnetic substance having great a saturation magnetization and a permeability is formed at both plurality of sides of the Bi mesa as a flux concentrator.
  - (Currently Amended) A spin FET (spin-polarized field effect transistor), comprising: a gate; an insulating layer on a portion of the gate; a source/drain region at a side of the insulating layer; and
    - a spin channel comprising [[the]] a Bi-containing film fabricated according to claim

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wherein the Bi-containing thin film has an MR ratio approximately 600% or more at room temperature and not less than 30,000% at 4 K when a magnetic field of 9T is applied.

12. (Currently Amended) A spin memory device, wherein the spin memory device comprises a gate, a Bi-containing spin channel fabricated by the method according to claim 1 on a portion of the gate and a source/drain region at a side of the spin channel, wherein the spin memory device controls resistance by an external magnetic field,

wherein the Bi-containing spin channel has an MR ratio approximately 600% or more at room temperature and not less than 30,000% at 4 K when a magnetic field of 9T is applied.

- 13. (Currently Amended) A magnetic field sensor comprising a mesa and a magnetic substance, wherein a the mesa comprises the Bi-containing film fabricated by the method of claim 7, and a the magnetic substance having a saturation magnetization and a permeability is formed at plurality of sides of the mesa as a flux concentrator.
  - 14. (Currently Amended) A spin FET (spin-polarized field effect transistor), comprising: a gate;
    an insulating layer on a portion of the gate;
    a source/drain region at a side of the insulating layer; and
    a spin channel comprising the Bi-containing film fabricated according to claim 7.
- 15. (Previously presented) The spin FET of claim 11, wherein the source/drain region is formed at a left or right side of the insulating layer by using magnetic metal or a magnetic semiconductor having great spin polarization.
- 16. (Previously presented) The spin FET of claim 14, wherein the source/drain region is formed at a left or right side of the insulating layer by using magnetic metal or a magnetic semiconductor having great spin polarization.
- 17. (Currently Amended) A spin memory device, wherein the spin memory device comprises a gate, a Bi-containing spin channel fabricated by a the method according to claim 7 on a

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portion of the gate and a source/drain region at a side of the spin channel, wherein the spin memory device controls resistance by an external magnetic field.

- 18. (Previously presented) The spin memory device of claim 12 wherein the source/drain region is formed at a side of the spin channel by using magnetic metal or a magnetic semiconductor having a spin polarization.
- 19. (Previously presented) The spin memory device of claim 17 wherein the source/drain region is formed at a side of the spin channel by using magnetic metal or a magnetic semiconductor having a spin polarization.
- 20. (Previously presented) The magnetic field sensor of claim 10, wherein the mesa produced by photolithography or electron beam lithography.
- 21. (Previously presented) The magnetic field sensor of claim 13, wherein the mesa produced by photolithography or electron beam lithography.